© Copyright	Composition De 2005. IPC, Bannockt and Pan-American co	ourn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, th	ent is a declarat he declaration e	ion of the su encompasses	bstances v s all lower	vithin the manufactur level materials for w	rer listed ite hich the ma	em. Note: i inufacturer	f the item is an as r has engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Response Date*				
onsemi										2024-04-24				
Contact Name Title - Con			Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - R			ele - Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Requester Item Number Mfr Iten		n Number Mfr Item Name			Effective Date	Version	М	Ianufacturing Site	W	veight*	UOM	Unit Type	
	AMIS30	AMIS30532C5321RG 3,2A Stepper Driver		ver		2024-04-24		Pl	PHG		55.58	mg	Each	
Aanufacturing Proccess Inf	ormation													
Terminal Plating / Grid A	Terminal Plating / Grid Array Material Terminal Base Al		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed CU All		CU Alloy	3			260	60 C 30		30	seconds 3				
omments														
TTENTION: MSL 3 Rated item r	requires Bake and D	ry Pack (after	electrical test)											
or more information regarding m	aterial composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	13.42	mg	Supplier	Silicon (Si)	7440-21-3		13.42	mg	
Die Attach	4.09	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.818	mg	
			Supplier	Silver (Ag)	7440-22-4		3.272	mg	
Lead Frame	86.87	mg	Supplier	Zinc (Zn)	7440-66-6		0.0869	mg	
			Supplier	Iron (Fe)	7439-89-6		1.998	mg	
			Supplier	Copper (Cu)	7440-50-8		84.6983	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0869	mg	
Mold Compound-Black	46.73	mg		Epoxy Phenol Resin	proprietary data		7.4768	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		39.2532	mg	
Plating	3.41	mg	Supplier	Tin (Sn)	7440-31-5		3.41	mg	
Wire Bond - Au	1.06	mg	Supplier	Gold (Au)	7440-57-5		1.06	mg	